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**POWER OF ATTORNEY BY ASSIGNEE OF ENTIRE INTEREST  
AND ASSIGNEE STATEMENT UNDER 37 C.F.R. § 3.73(b):**

BENQ Corporation, a Corporation, located at 157, Shan-Ying Rd., Kewishan, Taoyuan 333, Taiwan, R.O.C., as assignee of record of the entire interest of the of the subject matter which is claimed in the patent application entitled:

MOBILE PHONE AND MICROPHONE MODULE THEREIN

\_\_\_\_\_, which was filed on \_\_\_\_\_ as United States Application Serial Number \_\_\_\_\_, or for which the specification of which is attached hereto.

**POWER OF ATTORNEY:**

The following attorney(s) and/or patent agent(s) are hereby appointed to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

**Nelson A. Quintero, #52,143, of the firm Quintero Law Office**

The undersigned to this power of attorney hereby authorizes the attorneys named above to act and rely on instructions from and communicate directly with the person/attorney/firm/organization who/which first sends/sent this case. In the event of a change in the person(s) from whom instructions may be taken, the attorneys will be so notified by the undersigned.

**Please direct all correspondence to:**

Nelson A. Quintero, Esq.  
Quintero Law Office  
1617 Broadway, 3<sup>rd</sup> Floor  
Santa Monica, California 90404

**Please direct telephone calls to:**

Nelson A. Quintero  
1-310-401-6180

**ASSIGNEE STATEMENT UNDER 37 C.F.R. § 3.73(b):**

Assignee certifies that it is the assignee of the patent application identified above by virtue of an assignment from the inventor(s) of said patent application. The assignment was recorded in the Patent and Trademark Office at Reel \_\_\_\_\_, Frame \_\_\_\_\_, or for which a copy thereof is attached hereto.

The undersigned (whose title is supplied below) is empowered to sign this certificate on behalf of the assignee.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Dec. 9, 2003  
Date

Shen Woon Chen  
Signature

Shen Woon Chen  
Typed or printed name

Vice President  
Title

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**DECLARATION**  
Original United States Patent Application

As a below named inventor I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

MOBILE PHONE AND MICROPHONE MODULE THEREIN

**IDENTIFICATION OF SPECIFICATION:**

The specification of which is attached hereto unless the following item is checked:

\_\_\_\_\_ was filed on \_\_\_\_\_ as United States Application Serial Number \_\_\_\_\_ and was amended on \_\_\_\_\_ (if applicable).

**ACKNOWLEDGEMENT OF REVIEW OF PAPERS AND DUTY OF CANDOR:**

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56, including, for continuation-in-part applications, material information which became available between the filing date of the prior application and the continuation-in-part application.

**FOREIGN PRIORITY CLAIM:**

I hereby claim foreign priority benefits under Title 35, United States Code, §119(a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application(s) for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

APPLICATION NUMBER	COUNTRY	DATE OF FILING (day, month, year)	Certified Copy Attached
91221334	Taiwan, R.O.C	27-Dec-2002	<input checked="" type="checkbox"/>
			<input type="checkbox"/>
			<input type="checkbox"/>
			<input type="checkbox"/>

\_\_\_\_\_ Additional foreign application(s) are listed on a supplementary priority data sheet attached hereto.

**FOREIGN APPLICATIONS FILED MORE THAN 12 MONTHS PRIOR TO THIS U.S. APPLICATION:**

APPLICATION NUMBER	COUNTRY	DATE OF FILING (day, month, year)

\_\_\_\_\_ Additional foreign application(s) filed more than 12 months prior to this U.S. application are listed on a supplementary foreign application sheet attached hereto.

**DOMESTIC PRIORITY CLAIM**

I hereby claim the benefit under Title 35, United States Code, §119( ) of any United States provisional applications listed below.

APPLICATION NUMBER	DATE OF FILING (day, month, year)

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States Application in the matter provided by the first paragraph of Title 35, United States Code, §112, I acknowledge a duty to disclose material information as defined in Title 37, Coded of Federal Registrations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

APPLICATION NUMBER	DATE OF FILING (day, month, year)	STATUS (patented, pending, abandoned)

**DECLARATION:**

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

**SIGNATURE(S):**

<b>Full Name Of Inventor 1</b>	<b>Family Name</b> LIN	<b>First Given Name</b> Yi Yen	<b>Second Given Name</b>
<b>Residence &amp; Citizenship</b>	<b>City</b> Taipei	<b>State or Foreign Country</b> Taiwan, R.O.C.	<b>Country of Citizenship</b> Taiwan, R.O.C.
<b>Mailing Address</b>	<b>Address</b> 2Fl., No. 66-1, Lane 73, Dungyuan St., Wanhua Chiu, Taipei, Taiwan 108, R.O.C.	<b>City</b> Taipei	<b>State &amp; Zip Code/Country</b> Taiwan, R.O.C.
<b>Signature of Inventor 1:</b> <i>Lin Yi Yen</i>			<b>Date:</b> <i>Dec/02/'03</i>

\_\_\_ Additional inventors are listed on a supplementary inventor sheet attached hereto.